

National Aeronautics and Space Administration

# NEPP/NEPAG DC/DC Converter & Hybrid Working Group

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## Introduction

Mission: Create & Maintain Working environment for the communication of critical information on key issues regarding the reliability of Hybrid Microcircuits (with specific emphasis on DC/DC Converters ) addressing all aspects of product performance specifications, manufacturing, & procurement.

### Monthly Teleconferences

First Wednesday of every month @ 1:00p.m. EST

additional when / as necessary......

Usual Attendees: NASA Centers & JPL, Aerospace Corporation,





# Background

**Founded:** Spring 2001 time frame to help reduce risk of using DC-DC converters in hardware across the Agency. Initial thought was to provide forum for users to communicate about their converter experiences & challenges.

ailure Rate; %

- Similar forum to NEPAG meetings
- Lead by Langley EEE Parts personnel,
- Small User forum initially
- All Hybrids ( all MIL-PRF-38534 product )
- Power Converters still primary focus
- High risk commodity based on DPA Failure Rate
- Monthly Teleconferences
  - Customer Focused additional meetings when/as necessary...
  - Select Topics Address User needs:
  - Guest Component Vendor Product Briefings / Participation
  - Utilize Govt.Working Group for broader scope issues such as PIND, Hermeticity, Gas Analysis, Solder Seal...etc...as they apply to other commodities





## Motivation



### Switch Mode Power Supplies (DC/DC Converters)

- Enormously Complex due to Extreme Miniaturization
- High Risk due to type of Parts, Materials & Process used for assembly
- Paramount Programmatic Penalties [Budget, Time]
- Manufacturing challenges
  - Assembling hundreds of components using various techniques in a hermetic package (typically 1in<sup>2</sup> – 5in<sup>2</sup>)
  - Low production numbers
  - High reliability in extreme environments [verified by sampling & screening]

\* Data compiled from Hi-Rel Laboratories at Space Parts Working Group Conference presentation (2000-2022)



# **Working Group Key Points**

### General Topics

- Sharing of data on purchases, requirements, specifications (SMDs vs. SCDs)
  - Customizations by Centers and Product Performance Issues
  - Discussions on Failure Mechanisms, Purchase Lead time and delay issues

DC/DC - HYBRID

Workgroup

DLA

GWG

Manufacturer

- Sharing of information on failures, delays, GIDEPs, etc.
- Updates from Defense Logistics Agency
  - Moves, Consolidations, New ownership
  - Alternate Methods, \*\* specification changes/updates \*\*
- Attendance at JEDEC / G-12 Conferences (JC-13\* Government Liaison)
  - Attend 13.5 Hybrid Working Group Meetings (<u>Virtual</u> Attendance for 2021)

<sup>\*</sup> JC-13 is responsible for standardizing quality and reliability methodologies for solid state products used in military, space, and other environments requiring special-use condition capabilities beyond standard commercial practices. This includes long-term reliability and/or special screening requirements.

# Key Points (& more)

### General Topics

- Manufacturer Presentations Existing & New Product Line Introductions
- Radiation performance / Testing
- > Review of DLA Audits for certification/re-certification of Manufacturer facilities
  - (No Major Supplier visits for the Last 15 months ....) (considered alternatives)
  - (Discussed the various aspects of considering Virtual Audits.) (Group was Reluctant)
- Review of Specifications
  - > MIL-PRF-38534 (L), General Specification for Hybrid Microcircuits
  - MIL-STD-883, Test Method Standard for Microcircuits (X-ray, PIND, etc...)
  - Continuous Improvement efforts on existing Specification(s)
    - Element Evaluation, Worst Case Circuit Analysis(WCCA)
  - Enhance Quality Assurance Requirements for Space Application grades

# **Information Analysis**

### General Topics

- Manufacturer Proposals Existing Product Line Compliance Challenges
  - Vendor Alternate Method Proposal Reviews
- Radiation performance / Testing
- Review of Element Evaluation Tables & Test Methods
  - (Commercial Element Electronic part screening)
  - (BME Capacitor screening, Tantalum Capacitor Weibull grading)
  - (Subject Matter Expert Consultations)
- Review of Specifications
  - MIL-PRF-38534 (L), Element Evaluation Table Integrity
  - > MIL-STD-883, Test Method Standard for Microcircuits
  - Continuous Improvement efforts on existing Specifications
  - Enhance Quality Assurance Requirements for Space Application grades

# Star Maganese Parts

# **Monthly Meeting Topics**

### Specific Monthly General Topics

- Based on Current events, Working Group User Concerns & Visionary
- Hybrid SMD Thermal Datasheet Performance Discrepancies
- Worst Case Circuit Analysis (Wording in 38534 section E.4.2.9)
- Review of Element Evaluation Tables & Alternate Test Methods
  - (Commercial Element Electronic part screening)
  - (BME Capacitor screening , Tantalum Capacitor Weibull grading )
  - (Subject Matter Expert Consultations)
- Review related Issues Associated Hybrid radiography (883-TM2012)
- Review Issues with Wire Bond to Package Lid clearance Verification
- Review Update to EEE-INST-002 (for use in the new 8739.11)



### Additional Monthly Topics

- COVID-19 Pandemic Driven Quality/Reliability alternate Methods
  - Virtual Pre-Cap & Customer Source Inspections
  - Discussion on Expectations, Equipment Selection, usage and Methods
- Discussed Vendor Proposed Production Lot Definition
  - 38534 section 6.4.38 (Production Lot Homogeneity)
  - Discussion on Expectations for all aspects (PMP) for Purchase Order single lots
- Discussed Do's and Don'ts for Hybrid Life Test parts
- Review current status of Hybrid Vendor status & pending GIDEPS
- Review & Discuss User Community DPA failures
  - Internal Contamination
  - On-going Prohibited Materials issues (Pb Free Solders for example)



### And Even More Monthly Topics

- We covered "a lot of ground" in 2021-2022 Lockdown Timeframe
- Manufacturer Guest Presentations
  - for current QML status
  - new product introductions
  - Alternate Method Proposals commercial capacitor testing/element evaluation
- Review of Element Evaluation Tables for Die Thermal Testing
  - Table C-II and C-Iii
  - (Tri-Temp Disparity for Rev. L 38534 for Commercial Die Element screening)
  - (Table update introduced concerns over baseline parametric performance versus the maximum and minimum semiconductor and microcircuit dice performance )
- Metrics 12 Month Timeframe for Meetings
  - ➤ 13 Meetings , Over-a-Dozen "Key" Topics & also tending "Walk-On" Issues
  - Average Attendance is about 12 (Attendance range is about 10-15)



### More Details on the Monthly Topics

- Worst Case Circuit Analysis(WCCA) for Mil-PRF 38534
  - For Robust Product Quality/Reliability Design, Materials, Process, Test Verification
  - WCCA Documents the Addressing of Element Variation over Product Life Cycle/Environment
  - > Drives Data Sheet Performance Claims Verifiable by Parametric Test Results
  - Support for Survey Generation– DLA Distributed/Collected Feedback HWG Analyzed & Interpreted
  - Survey analysis & results were used to assess proposed wording acceptability.
- Production Lot Homogeneity Definition for Mil-PRF 38534
  - For Users with Single Lot Date Code purchases Definition defines Homogeneity of Production Lot
- BME Capacitor Element Evaluation Concerns
  - Vendor specific alternate method proposal review/consultation(s) (Voltage Levels Stress Tesing)
- GIDEP Alert related discussions vendor QML status stop shipment notices
  - Substrate Vendor Certification Issue Affected Major Hybrid Supplier Customer Notification Letters



### More Details on the Monthly Topics

- Tri-Temp Disparity in Element Evaluation tables in section C.3.3.4.3
  - Agreement to initially test at 25'C <u>only</u> (Table C-II-1 and C-II-1a)
  - Elements go thru Burn-In at 125'C and then Post Burn-In is performed at Tri-Temp (-55,25,+125)
- User Walk On Topics
  - Guideline for SCD formulation when qualified product is not available
- Prohibited Materials User DPA Test Data results
  - > Pure Tin usage topic User Experiences Internal Inspection High Temp Solders
- Non-Destructive Bond Pull Alternate Method review/consultation
  - Challenges when Device Bond Pads are small but multiple wire bonds are required
  - Test Hook placement/geometries lack of space wire damage concerns
- JEDEC JC13.5 Meeting preparations topic concerns
  - > NASA/GWG "One Position"



### **Failure Trends**



### Singe Decade Trending for Hybrid Microcircuits

- Based on DPA Test Results Snapshot Relative indicator for trending
- Used as indicator for where triage may be needed.
- Failures for various reasons (in 2021): (of the 33% that failed)
  - 42% failed Internal Visual Inspection, 19% failed X-ray
  - 15 % failed Prohibited Materials, 25% Failed SEM (scanning electronic microscopy)
  - 9% failed Bond Pull, 16% RGA (residual gas analysis), 3% External Visual
  - 11% PIND
  - 3% Hermeticity

\* Data compiled from Hi-Rel Laboratories at Space Parts Working Group Conference presentation (2000-2022)





### Failure Trends (& more)

### Two Decade Trending for Hybrid Microcircuits

- MIL-PRF-38534 rev(D) applicable for 1999
- MIL-PRF-38534 rev(K) applicable for 2019 (rev L released in Dec.'19)
  - Letters below: Denote what MIL-PRF-38534 revision was in effect



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#### There is more trending analysis work to be done here !



# **Performance Specification**

#### **DLA Approved QML-38534 Vendor Listing**

- 31 approved vendors (Typically we discuss the top 5)
- Various functions in addition to DC-DC converters
  - Optical Imaging Detectors, RF, Amplification, Opto-couplers, Motor Controllers, Digital Communications
  - Dilemma: Products with single die and few passive parts look like MIL-PRF-38535 type product, are qualified and approved as MIL-PRF-38534

#### Current Specification at Revision Level - L

- Approved December 2019 Change Summary was about 40+
  - About 2 years of work to address related issues, rewording and change coordination (for element evaluation, Worst Case Circuit Analysis, periodic conformance, Production Lot homogeneity Definition, etc....)
- No Significant Changes
  - Completed updates to Element Evaluation Tables ( Die Tri-Temp fix in the works)
  - Addressed "existing inventory" for compliance to new revision level L



## **Performance Changes +**

#### Current Specification at Revision Level – L (continued)

- Rev L (Hybrid User community working to change WCCA & Single LDC at this time )
- Element Evaluation tables are considered strong and unchanged
  - Only minor typos are considered needing attention no philosophical
  - Microcircuit/Semiconductor Die Tri-Temp typo correction in the works
- For Class K: "Group C inspection will be performed periodically within a maximum of five years for periodic re-qualification".
- In Progress for Rev M
  - Restoring / Enhancing Worst Case Circuit Analysis (WCCA) requirements
  - Rev K removed "Worst case" from "circuit design analysis" requirement
  - Add WCCA parameters such as initial tolerances, temperature, aging, radiation (if applicable)

Key Performance Criteria for Robust High Quality & Reliability type products

### **Current Actions**

### Audits

- No H & K Hybrid Audits since early 2020 [NASA Representation]
  - CoViD-19 Travel Impact also limited FY2021 audits (none)
    - (In preparation for CoViD-19 restrictions rescinding User community has audit "wish list" queue for major suppliers)
  - Urgent audit of manufacturer experiencing issues (as necessary)
    - or when factory/production lines are physically moved
  - Under review during typical audit
    - Derating Plan / Stress Analysis
    - Failure Analysis (Customer returns)
    - Festing

- Audit Update:
  - 1<sup>st</sup> Audit completed May'22
- Reports Submitted/Available on NASA SCIC website (replaced SAS)
- \*\*\* Still Working with JC-13.5 to get WCCA approach/wording changes implemented & ensure standardization of all hybrids application reliability performance. \*\*\*



### **Future Actions**

### Military Specifications

- MIL-STD-883 TM 2017 (Internal Inspections Hybrids)
- Gen Spec for Hybrids (MIL-PRF-38534) next revision level
  - Completed of Rev L work Only Update changes envisioned (typos?)
  - Get WCCA and Production Lot definitions Updated ...taking awhile.
  - Need to consider Retrospective review of changes in order to....

### Continuous Improvements to Selection Tool(s)

- Over 1500+ DC-DC converter SMD's
- Need to include Point of Load converters
- Understand custom environmental performances (temperature, linear derating, WCCA etc...)



### Where do we need to be 5 years from now.

- Vendor Audit Performance/Analysis and Prioritization
- Ensure Spec. for Hybrids (MIL-PRF-38534) is "clean"/no loop holes
- Better Selection tools for Hybrids to aid in reducing application risk

> When do we start planning for the use of COTs related to Hybrids?

- We're already doing it via Alternate Method approaches with 38534 Vendors \*\*\*
- Limited Use via exception heritage product spec changes conservative designs
- We need to ensure continued involvement from all NASA Centers!
- Application & Product failure data needed for awareness/metrics
- Need information on procurements, failures, CSI's , lessons learned, etc.
- Virtual Inspection Tools We can Thank CoVid for this inspiration.

But acceptance of applicability/use will be slow by the user community.





# **QUESTIONS / FEEDBACK**

